



DBS100A,150A Reliability Test results

Nov 20, 2008
OS Design DEPT.

Approved : Tatsuya Mano
Tatsuya Mano

Prepared : Takuya Mori
Takuya Mori

No.	Test item	Testing conditions	Conditions of acceptability	Number of samples	Number of failures
1	Heat cycle test	(1) -40°C ~ 125°C 30minutes each (2) 600cycles	(1)No degradation of electric characteristics after test.	5	0
2	High temperature/ High humidity bias test	(1) Ta=85°C,RH=85% (2) At rated input (3) Load 0% (4) 1000hours	(1)No degradation of electric characteristics after test.	3	0
3	Vibration test	(1) f=10~55Hz,49.0m/s ² (5G) (2) 3minutes period (3) 1hour each X,Y and Z axis	(1)No degradation of electric characteristics after test. (2)No crack at solder joint. (3)No marked damage of appearance.	3	0
4	Impact test	(1) 196.1m/s ² (20G).11ms (2) Once each X,Y and Z axis	(1)No degradation of electric characteristics after test. (2)No crack at solder joint. (3)No marked damage of appearance.	3	0
5	Soldering heat test	(1) 260°C,15seconds (2) Mounting board : t=1.6mm / FR-4	(1)No crack at solder joint. (2)No marked damage of appearance.	1	0
6	Pin strength test immunity test	(1) Weight ϕ 1 pin : 1kg (2) Bending angle:90 deg., total 180 deg. (3) 1 cycle	(1)No degradation of electric characteristics after test. (2)No broken or bent pin.	1	0
7	Static electricity immunity test	(1) Applied voltage \pm 8kV (2) At rated input and load	(1)No protection circuit fail. (2)No output voltage drop with control circuit fail. (3)No any other function fail.	1	0